Product Specification

108-5238-1

AMPLIMITE 050 SERIES II CONNECTOR TYPE B

1. Scope:

1.1 Contents

This specification covers the requirements for product performance, test methods and quality assurance provisions of counter-EMI products (Fig. 1) of AMPLIMITE 050 Series $\,$ II connector type $\,$ B $\,$.

The applicable product descriptions and part number are as shown in Fig. 1:

Product No.	Product Name	Remarks
□-174340-□	Plug Connector Kit	Wire Side (AWG #28)
□-175705-□	Plug Connector Kit	Wire Side (AWG #30)
□-174225-□	Horizontal Type Cap Header	M 2.5 Screw
□-174341-□	Horizontal Type Cap Header	w/Retention Leg
□-175714-□	Plug Connector Kit	Wire Side (AWG #28)
□-175644-□	Plug Connector Kit	Wire Side (AWG #28) for Flat Ribbon Cable
□-174339-□	Vertical Type Cap Header	M 2.5 Screw

Fig. 1

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			_	<u> </u>	<u> </u>	R. NISHIMURA	1			AM	P (Japan), Ltd.	
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2. Type of the Products:

Connectors of this product line are designed for wire-to-board mass termination. Further, shield effect is applied for prevention of EMI.

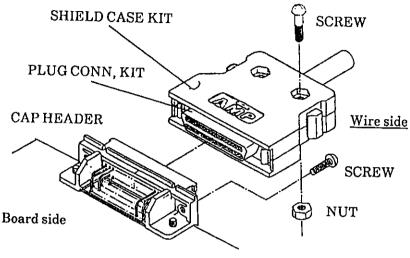


Fig. 2

3. Product Specifications:

Product Design Feature, Construction and Dimensions: 3.1

The product structure, shape and dimensions shall conform to requirements shown on applicable drawings, unless otherwise specified below.

(1) Number of Positions

20, 28, 36, 50, 68 Pos. in 5 Types

(2) Pitch and Row

Engaging Side:

1.27 mm pitch \times 2.54 mm in 2 rows

Board Mount Side: 2.54 mm pitch $\times 1.905 \text{ mm}$ in zigzag of 4 rows

(3) Cap Header Type

Horizontal/Panel & Board Mount Type

(4) Mounting on Panel & Board Screw Mount (M 2.5 Screws) / Self Mount (Retention Leg)

(5) Applicable Panel

1.6 mm max.

(6) Applicable Board

Thickness:

0.8-1.6 mm Solder-Resistance

Treatment to be applied on soldering face.

(7) Applicable Wire Size

To be specified in Fig. 3.

Wire Size	Conductor (Tin-pla	ited mild copper wire)	Insulatio	<u> </u>	
A TUC #00	Composition	Outside Diameter	Outside Diameter		Remarks
AWG #28	7/0.127	0.38		 	
AWG #30	7/0.1	0.3	√ 0.5~0.75	PVC or	Discrete
AWG #28	7/0.127	0.38	1.0 MAX	equivalent	Flat Ribbon

Fig. 3

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3.2 Material and Finish:

(1) Receptacle Contact: Material: Phosphor Bronze

Finish: $1.0~\mu\mathrm{m}$ min. thick nickel underplate all over 0.2 $\mu\mathrm{m}$ or 0.76 $\mu\mathrm{m}$

min. thick gold-plated for contact area only, and 1.0 μ m min.

thick solder-plated for termination area.

(2) Post Contact:

Material: Phosphor Bronze

Finish:

1.0 m min. thick nickel underplate all over 0.2 μm or 0.76 μm

min. thick gold-plated for contact area only, and 1.0 μ m min.

thick solder-plated for type area only

(3) Plug, Cap, Cover Housing and Tyne Plate:

Material: Glass-filled Thermoplastic, Polyester

UL Flame Retardant Grade: UL 94V-0

Color:

Black / Gray

(4) Plug Metal Shell:

Material: Cold Rolled Steel Sheet

Finish:

Bright-tin Plating over Copper Underplate

(5) Cap Metal Shell:

Material: Zinc Die Cast

Finish:

Nickel-plasted over Copper Underplate

(6) Locking Spring:

Material: Stainless Steel

(7) Shield Case:

Material: Molded ABS Resin, and Zinc Die Cast

Finish:

Nickel-plated over Copper Underplate

3.3 Appearance:

> The connectors shall be free from scratches, cracking, deformation, blister, dirt and burrs, that are detrimental to connector functions and merchandising value.

Product Performance:

4.1 Rating:

(1) Rated Voltage:

AC 100 V

(2) Rated Current:

1 A max.

(3) Operating Temperature Range: -55 °C~+85 °C

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4.2 Quality Assurance Provisions:

4.2.1 Test Environments:

The performance test shall be made on the environmental conditions listed below, unless otherwise specified.

Temperature:

15~35°C

Relative Humidity:

45~75%

Atmospheric Pressure: 650~800 mmHg

4.2.2 Test Samples:

- (1) The product samples to be used at the performance test shall conform to applicable product drawings.
- (2) Wires to be used for termination shall conform to those specified in Para. 3.1 (7) and applicable tools shall be used for termination.
- (3) No test sample shall be reused in the test, unless otherwise specified.
- (4) Shield case is excluded from the testing items.

4.3 Electrical Performance:

Para.	Test Items	Requirements	Procedures
		Electrical Requiremen	nts
4.3.1	Termination Resistance (Low Level)	Initial: 20 mΩ max. After test: 30 mΩ max.	To be measured by using open circuit voltage of 50 mV max. with closed circuit current of 50 mA max. flowing through the test circuit shown in Fig. 6.
4.3.2	Insulation Resistance	1000 ΜΩ	Engage connectors, and measure resistance between adjacent connectors per Condition B (500 V ± 10 %), Test Method 302 of MIL-STD-202.

Fig. 4 (To be continued)

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_	Para.	Test Items		Requireme	ents	Procedures		
108-5238-1	4.3.3	Dielectric Strength	No abnormalities such as insulation break-down or flashover shall take place during the test.			Engage connectors, and apply AC 500 V (RMS) between the adjacent contacts for 1 min. per Test Method 301 of MIL-STD-202.		
omer number:	4.3.4	Temperature Rising vs. Current	30°C	max.		After all the contacts serieswired, mate connectors, and measure temperature rising at the points shown in Fig. 6 by thermocouple method. Use test current of 1 A and from the measured value, deduct the room temperature.		
Customer Release		4.4.1 Connectpor Insertion / Extraction	# of Pos.	Insertion	Extraction	Attach plug and cap assemblies properly to tensile tester, insert and		
	4.4.1	Force	20	2.0 kg max.	0.5 kg min.	extract at the rate of speed of 100		
TION:			28	3.0 kg max.	0.6 kg min.	mm/min., and read the insertion and extraction forces required.		
SECURITY CLASSIFICATION:			36	5.0 kg max.	0.8 kg min.	* The value regarding grounding		
¥3			50	6.0 kg max.	1.0 kg min.	indents is to be separately specified.		
			68	7.5 kg max.	1.5 kg min.			
			96	10.5 kg max.	2.0 kg min.			
		·						
	4.4.2	Durability (Repeated Mate/Unmating)	(Appearance) No physical problem tolerated. (Low-level Termination Resistance) To meet 4.3.1. (Insertion/Extraction Force) To meet 4.4.1.			Repeat insertion and extraction for 500 cycles in the same manner as specified in Para. 4.4.1.		

Fig. 4 (To be continued)

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-	Para.	Test Items	Requirements	Procedures
Kelease	4.4.3	Vibration Sinusoidal High Frequency	No electrical discontinuity greater than 1 microsecond shall take place during the test. (Low-level Termination Resistance) To meet 4.3.1 (Appearance) No physical problem tolerated.	Engage the connectors with all the contacts series-wired, apply test vibration changing to reciprocate 10-500-10 Hz one cycle every 15 min. to the connector fixed on the jig. Maximum amplitude shall be 1.52 mm both sides, 10 G at the peak, as specified in Test Condition A, Test Method 204 of MIL-STD-202. Vibration shall be applied to three axial directions 3 hours each, totally 9 hours.
A A A	4.4.4	Physical Shock		Engage the connectors with all the contacts series-wired, and applying test current of 100 mA to the circuit, test in accordance with Test Condition A, Test Method 213 of MIL-STD-202. The vibration shall be: Standard holding time: 6 mesc. Max. value: 50 g's Waveform: Semi-sine waveform Directions and Number of Cycles: 3 Drops each in X, Y and Z (total 18 times)
	4.4.5	Resistance to Soldering Heat	problems as play in contact, cracking and deformation of housing.	Mount connector on the board, and dip in a molten solder bath so that the underside of the board is held in the bath. Molten solder Temperature: 260±5°C Dipping time: 3 sec.

Fig. 4 (to be continued)

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Para.	Test Items	Requirements		Procedu	rec	
		nts		103		
4.5.1	Humidity-Temperature Cycling	(Insulation Resistance) 500 M min. (Dielectric Strength) To meet 4.3.3. (Low-level Termination Resistance) To meet 4.3.1.	Meth Test °C→6 humi	age connectors, and 106 D of MIL-S cycle (24 hrs.): 25 55 °C→25 °C unde dity of 80~98%. at this test cycle 1	STD-202. °C→65°C→2 r relative	
Thermal Shock	(Low-level Termination Resistance) To meet 4.3.1. (Appearance) No physical problem tolerated.	Engage connectors, and test 5 cycles end per Condition A (see table below) Test Method 107 D of MIL-STD-202.				
			Step	Temp. (°C)	Time (min.	
			1	$-55 \begin{array}{r} +0 \\ -3 \end{array}$	30	
			2	$25 \begin{array}{c} +10 \\ -5 \end{array}$	5 Max.	
			3	85 +3 -0	30	
			4	25 +10 -5	5 Max.	
4.5.3		(Low-level Termination Resistance) To meet 4.3.1. (Appearance) No physical problem tolerated.	hrs. at	e connectors, and 85±2°C (Conditi 1108 A of MIL-ST	ion B) per Test	

Fig. 4 (end)

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5. Test Sequence:

All the tests shall be performed in accordance with the test sequence specified below.

	Item No.	Test Group							
Test Item		1	2	3	4	5	6	7	8
Appearance	3.3	1	1	1	1	1	1	1	1
Low-level Termination Resistance (Initial)	4.3.1	3	2	2	2	2			
Insuration Resistance (Initial)	4.3.2						2		
Dielectric Strrngth (Initial)	4.3.3						3		
Temperature Rising	4.3.4							2	
Connector Insuretion / Extraction Force	4.4.1	2							
Durability	4.4.2	4							
High Frequency Vibration	4.4.3					3			
Physical Shock	4.4.4					4			
Soldering Heat Resistivity	4.4.5								2
Humidity Resistance	4.5.1		3				4		
Thermal Shock	4.5.2			3					
Heat Aging	4.5.3				3			:	
Low-level Termination Resistance (Final)	4.3.1	6	4	4	4	5			
Insulation Resistance (Final)	4.3.2						5		
Dielectric Strength (Final)	4.3.3						6		
Connector Insertion / Extraction Force (End)	4.4.1	5							
Appearance (End)	3.3		5	5	5	6	7	3	3
No. of Test Samples			3	3	3	3	3	1	1

(Note) 1. To be tested in groups in sequence indicated by encircled figure.

Fig. 5

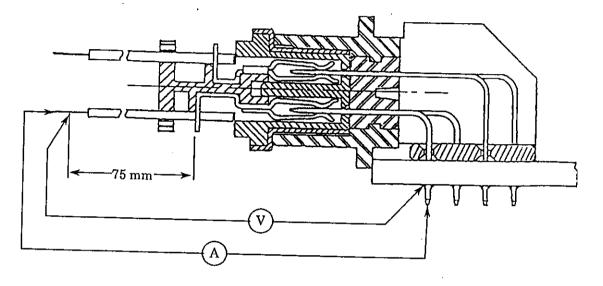
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NUMBER:

Customer Release

SECURITY CLASSIFICATION: [Measurement of Low-level Resistance]



Low-level Resistance = Measured Reading — Wire Resistance (75 mm)

Fig. 6

